

**◆ Features:**

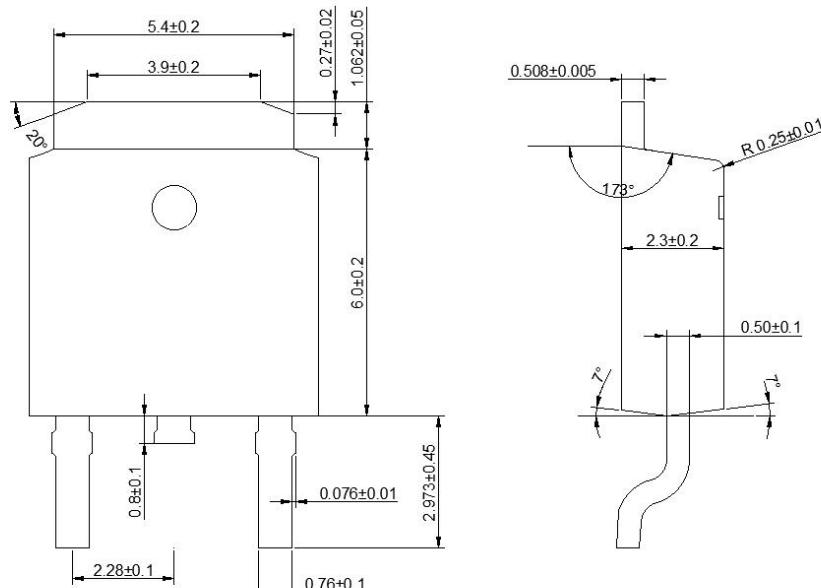
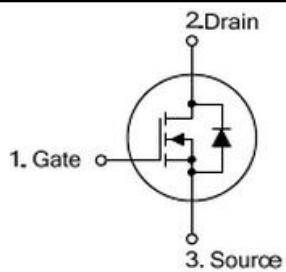
- ◊ Fast switching speed  
开关速度快
- ◊ High input impedance and low level drive  
高输入阻抗和低电平驱动
- ◊ Avalanche energy tested  
雪崩能量测试
- ◊ Improved dv/dt capability, high ruggedness  
提高 dv/dt 能力，高耐用性

**TO-252**

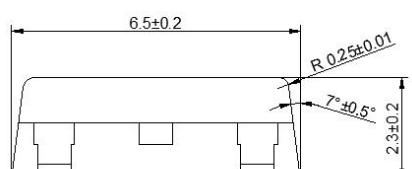
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**◆ Applications**

- ◊ High efficiency switch mode power supplies  
高效率开关电源
- ◊ Power factor correction  
功率因数校正
- ◊ Electronic lamp ballast  
电子整流器



单位: mm  
**TO-252**





OSD50N06T

60V N-CHANNEL MOSFET

<http://www.osen.net.cn>

## ◆ Absolute Maximum Ratings (Tc=25°C)

Symbol	Parameters	Ratings		Unit
V <sub>DSS</sub>	Drain-Source Voltage 漏源电压	60		V
V <sub>GS</sub>	Gate-Source Voltage-Continuous 栅源电压	±20		V
I <sub>D</sub>	Drain Current-Continuous (Note 2) 漏极持续电流	50		A
I <sub>DM</sub>	Drain Current-Single Plused (Note 1) 漏极单次脉冲电流	200		A
P <sub>D</sub>	Power Dissipation (Note 2) 功率损耗	60		W
T <sub>j</sub>	Max.Operating junction temperature 最大结温	150		°C

## ◆ Electrical characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameters	Min	Typ	Max	Units	Conditions
<b>Static Characteristics</b>						
B <sub>VDSS</sub>	Drain-Source Breakdown VoltageCurrent (Note 1) 漏极击穿电压	60	--	--	V	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C
V <sub>GS(th)</sub>	Gate Threshold Voltage 栅极开启电压	1.1	1.6	2.1	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
R <sub>DS(on)</sub>	Drain-Source On-Resistance 漏源导通电阻	--	13.5	15.5	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =20A
I <sub>GSS</sub>	Gate-Body Leakage Current 栅极漏电流	--	--	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current 零栅极电压漏极电流	--	--	1	μA	V <sub>DS</sub> =60V, V <sub>GS</sub> =0
g <sub>fS</sub>	Forward Transconductance 正向跨导	25	--	--	S	V <sub>DS</sub> =30V, I <sub>D</sub> =25A



OSD50N06T

60V N-CHANNEL MOSFET

## Switching Characteristics

$T_{d(on)}$	Turn-On Delay Time 开启延迟时间	--	<b>22</b>	--	ns	$V_{DS}=30V, I_D=25A,$ $R_G=50\Omega$ (Note 2)
$T_r$	Rise Time 上升时间	--	<b>15</b>	--	ns	
$T_{d(off)}$	Turn-Off Delay Time 关闭延迟时间	--	<b>50</b>	--	ns	
$T_f$	Fall Time 下降时间	--	<b>40</b>	--	ns	
$Q_g$	Total Gate Charge 栅极总电荷	--	<b>39</b>	--	nC	$V_{DS}=48V$ , $V_{GS}=10V,$ $I_D=50A$ (Note 2)
$Q_{gs}$	Gate-Source Charge 栅源极电荷	--	<b>9.3</b>	--	nC	
$Q_{gd}$	Gate-Drain Charge 栅漏极电荷	--	<b>13</b>	--	nC	

## Dynamic Characteristics

$C_{iss}$	Input Capacitance 输入电容	--	<b>900</b>	--	pF	$V_{DS}=25V, V_{GS}=0,$ $f=1MHz$
$C_{oss}$	Output Capacitance 输出电容	--	<b>130</b>	--	pF	
$C_{rss}$	Reverse Transfer Capacitance 反向传输电容	--	<b>25</b>	--	pF	
$I_S$	Continuous Drain-Source Diode Forward Current (Note 2) 二极管导通正向持续电流	--	--	<b>50</b>	A	
$V_{SD}$	Diode Forward On-Voltage 二极管正向导通电压	--	--	<b>1.4</b>	V	$I_S=20A, V_{GS}=0$
$R_{th(j-c)}$	Thermal Resistance, Junction to Case 结到外壳的热阻	--	--	<b>2.08</b>	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW &lt;= 300us , duty cycle &lt;= 2%.